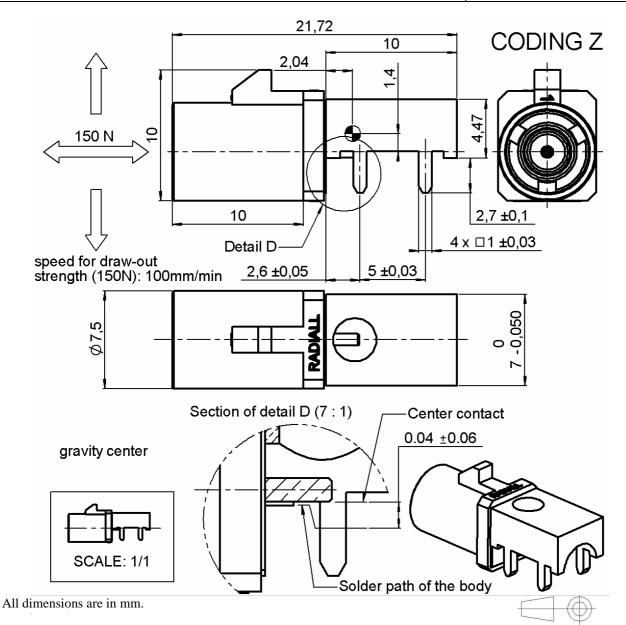
# **EDGE CARD - PIN IN PASTE VERSION**

R197.160.Z07

Series : SMB CARLOCK



COMPONENTS	MATERIALS	PLATING (µm)	
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS -	BRASS BRASS - PTFE	GOLD 0.2 OVER GOLD 0.5 OVER - -	
HOUSING PA	4.6 30%GF	LASSIFICATION UL 94 V2  * Acco	COLOR Water Blue RAL 5021 ording to FAKRA specification

**Issue:** 0636 A



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#### **PACKAGING**

Standard	Unit	Other
350	'W' option	Contact us

### **SPECIFICATION**

**QS9000** 

# **ELECTRICAL CHARACTERISTICS**

Impedance 50  $\Omega$ 

Frequency 0-4 GHz

VSWR 1.06\* + 0,0130 x F(GHz) Maxi Insertion loss 0.03\*  $\sqrt{F(GHz)}$  dB Maxi

RF leakage - ( - F(GHz) dB Maxi

 $\begin{array}{ccc} \mbox{Voltage rating} & \mbox{335} & \mbox{Veff Maxi} \\ \mbox{Dielectric withstanding voltage} & \mbox{1000} & \mbox{Veff mini} \\ \mbox{Insulation resistance} & \mbox{1000} & \mbox{M}\Omega \mbox{ mini} \\ \end{array}$ 

# **ENVIRONMENTAL**

Operating temperature -40/+110 ° C

Hermetic seal NA Atm.cm3/s

Panel leakage NA

### OTHER CHARACTERISTICS

Assembly instruction

Others:

\*COAX TRANSMISSION LINE ONLY

### **MECHANICAL CHARACTERISTICS**

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

10 N mini
NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 100 Cycles mini

Weight **2,7900** g

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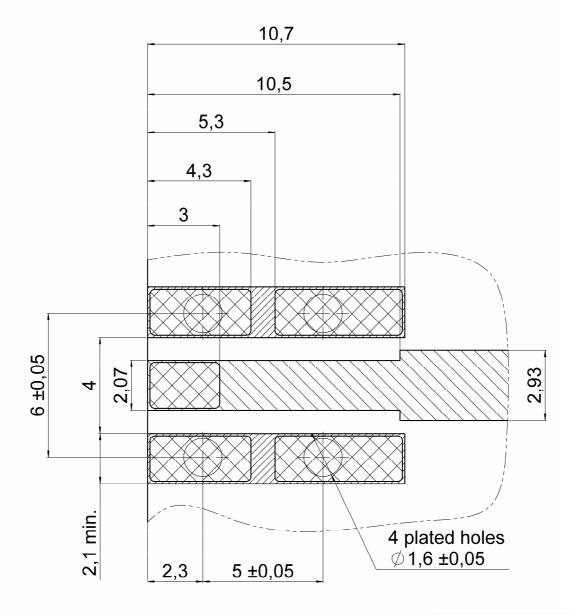


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# MOUNTING ZONE FOR RECEPTACLE



Thickness of PCB: 1,6 mm.

Material of PCB: FR4 ( $\varepsilon r = 4.6$ ).

Solder paste has to be printed onto the land of solder and into holes to permit Pin In Hole Reflow Ground track

Signal track

Land for solder

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### **EDGE CARD - PIN IN PASTE VERSION**

# **SOLDER PROCEDURE**

Deposit solder paste "Sn Ag4 Cu0.5" on mounting zone by screen printing application. We recommend a low Residue Solid Flux.

We advise a thickness of 0,2 millimetres min. (0,008 inch min.).

The holes must be totaly filled with cream

Verify that the edges of the zone are clean.

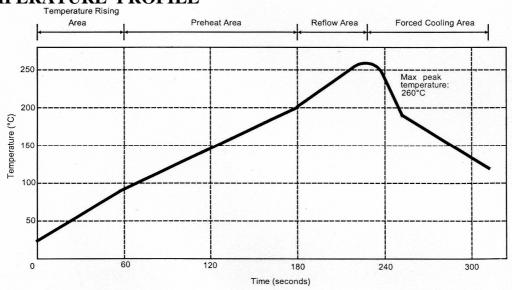
- Placement of the receptacle on the mounting zone with an automatic machine of "pick and place" type.

Video camera is preferred to check the positioning of the component.

Adhesive agents are forbidden on the receptacle.

- Soldering by reflow process.
  - The typical profile to use is given below.
- Clean printed circuit boards.
- Check of solder joints and position of the component by visual inspection

## TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

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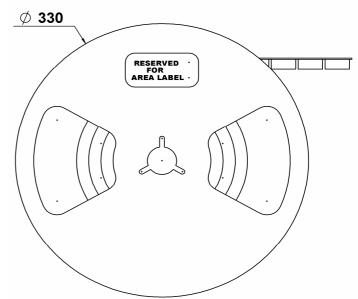
### **EDGE CARD - PIN IN PASTE VERSION**

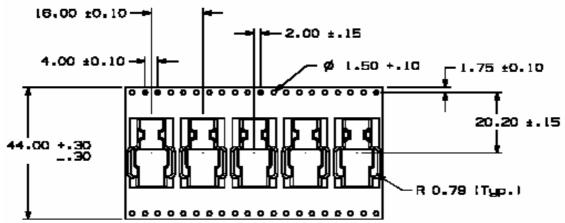
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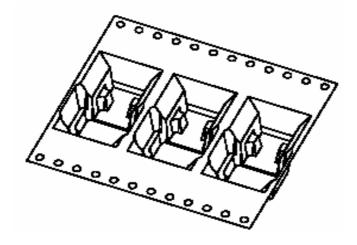
Series : SMB CARLOCK

# **REEL PAKAGING PER 350**

CELL MATERIAL : Polycarbonate COVER TAPE MATERIAL : conductive polyester film tape





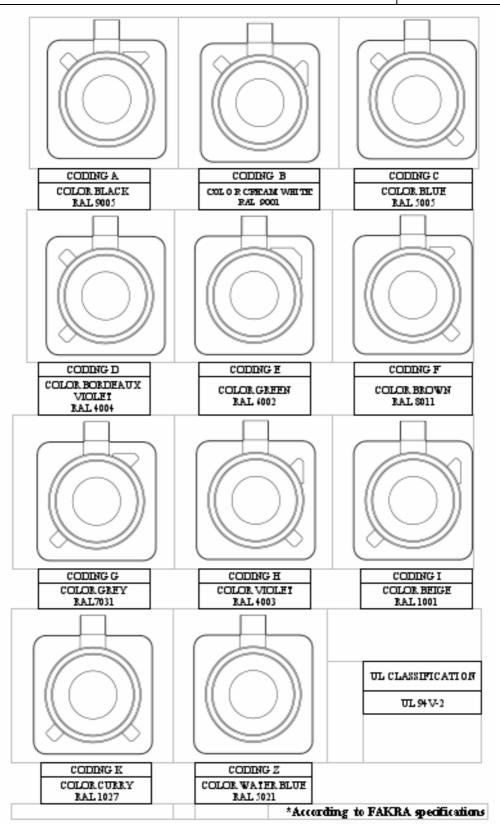




### **EDGE CARD - PIN IN PASTE VERSION**

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To obtain other coding for the connector please change the letter by the needed coding letter into the Part Number

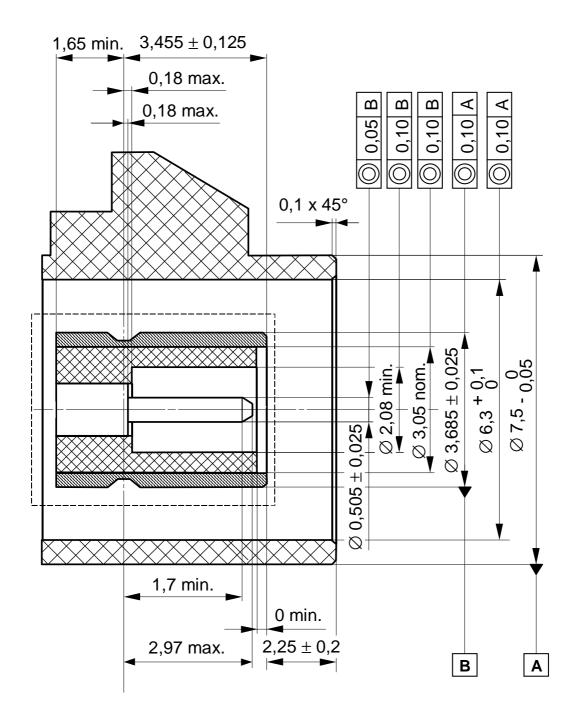
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# **EDGE CARD - PIN IN PASTE VERSION**

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